



Product Change Notification

110291 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 110291 - 00
Change Title: Intel (R) Remote Management Module 3 kit
AXXRMM3, PCN 110291-00, Product
Design, Memory Flash Chip Change
Date of Publication: October 28, 2010

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jan 07, 2011
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Description of Change to the Customer:

The source part of AXXRMM3 memory flash chip is changing to Winbond* E65762-001 because the original source Winbond* E45446-002 is discontinued.

The AXXRMM3 PBA will change from E26434-303 to E26434-304.

The AXXRMM3 is the accessory of Intel(R) Server Board S5520UR, S5520URT, S5500BC, S5520HC, S5520HCT, S5520SC, S5500WB, S3420GP and Intel(R) Server System SR1600UR, SR1625UR, SR2600UR, SR2625UR, SR2612UR, SR5650HC, SR5650BC, SR1630BC, SR1695WB, SR1690WB, SC5650SC, SR1630GP.

Customer Impact of Change and Recommended Action:

Intel does not foresee any adverse customer impact to these changes. Intel recommends performing a standard level of evaluation as updated product becomes available.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
AXXRMM3	900961	E50263-004	E26434-303	E50263-005	E26434-304

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 28, 2010	00	Originally Published PCN